C	Material Composit © Copyright 2005. IPC, I nternational and Pan-An	Bannockb	urn, Illinois. A	ll rights reserved utions.	under both	This docume level parts, t	ent is a declarat he declaration e	on of the su	ibstances v s all lower	vithin the manufact level materials for	turer listed which the	item. Note: manufacture	if the item is an as r has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information				
upplier Informati	on														
Company name*			Company unique ID				Unique ID Authority				Respo	Response Date*			
onsemi											2023-0	2023-06-08			
Contact Name			Title - Contact				Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative				Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards			Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Ite	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date	ctive Date Version Manufacturing Site			Weight*	UOM	Unit Type		
		FAN2558	FAN2558S35X Low Volt 18		80mA LDO		2023-06-08		PI	PBB		17.013	mg	Each	
Ianufacturing Pro	occess Information	1													
Terminal Plating / Grid Array Material Terminal H			erminal Base A	e Alloy J-STD-020 MSL Rating			Peak Process Body Temperature Max Time at Peak			ık Temper	Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU			J Alloy 1				260 C 30			seco	seconds 3				
omments															
vel 1 - maximum time	at peak temperature d	luring sol	dering is 10-3	0 seconds											
or more information r	egarding material com	position j	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl obthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select select a RoHS exemption, if applic sigma range of distribution unless	cable [E] enter the weigh	Requester or Supplier) [B t of the substance or the Pl] select the substa PM concentration	ance category (JIG or Requester) or enter a [F] Optionally enter the positive (+) and n	value (Supplier). [C] se egative (-) tolerance in p	lect the substance (Jl percent (Note: percer	G) or enter the substant tolerance values are	nce and CAS (Other). [D] expected to cover a 3
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.745	mg	Supplier	Silicon (Si)	7440-21-3		0.745	mg
Die Attach	0.052	mg	Supplier	Silver (Ag)	7440-22-4		0.0439	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0081	mg
Lead Frame	7.29	mg	Supplier	Silver (Ag)	7440-22-4		0.008	mg
			Supplier	Copper (Cu)	7440-50-8		7.282	mg
Mold Compound-Black	8.4	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.68	mg
			Supplier	Carbon Black (C)	1333-86-4		0.084	mg
			Supplier	Silica (SiO2)	14464-46-1		6.636	mg
Plating	0.453	mg	Supplier	Tin (Sn)	7440-31-5		0.453	mg
Wire Bond - Au	0.073	mg	Supplier	Gold (Au)	7440-57-5		0.073	mg